molex

Part Number: 444320611

Product Description: Micro-Fit BMI Header, Surface Mount Compatible, Dual Row, Vertical, with PCB Polarizing Peg, 6 Circuits, 0.38µm Gold (Au) Selective Plating, Straight

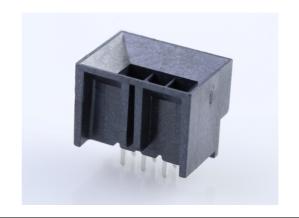
Tails

Series Number: 44432

Status: Active

Product Category: PCB Headers and

Receptacles



Documents & Resources

Drawings

444320611_sd.pdf PK-44432-001-001.pdf

3D Models and Design Files

444320611_stp.zip

Specifications

1722990000-AS-000.pdf PS-44300-001-001.pdf 443000002-TS-000.pdf

Product Environment Compliance

Compliance

GADSL/IMDS	Not Relevant
China RoHS	•
EU ELV	Not Relevant
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2024)4144-DC (27 June 2024)
EU RoHS	Compliant per EU 2015/863

Multiple Part Product Compliance Statements

- Eu RoHS
- REACH SVHC
- Low-Halogen

Multiple Part Industry Compliance Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

EU RoHS Certificate of Compliance

Part Details

General

Status	Active
Category	PCB Headers and Receptacles
Series	44432
Description	Micro-Fit BMI Header, Surface Mount Compatible, Dual Row, Vertical, with PCB Polarizing Peg, 6 Circuits, 0.38µm Gold (Au) Selective Plating, Straight Tails
Application	Board-to-Board, Power, Wire-to- Board
Comments	High Temperature, Square Pin, Solder Type
Component Type	PCB Header
Product Name	Micro-Fit BMI
UPC	191128454100

Agency

CSA	LR19980
UL	E29179

Electrical

Current - Maximum per Contact	8.5A
Voltage - Maximum	250V AC (RMS)/DC

Physical

Breakaway	No
Circuits (Loaded)	6
Circuits (maximum)	6

Color - Resin	Black
Durability (mating cycles max)	30
Flammability	94V-0
Glow-Wire Capable	No
Material - Metal	Brass
Material - Plating Mating	Gold
Material - Plating Termination	Matte Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	1.458/g
Number of Rows	2
Orientation	Vertical
Packaging Type	Tray
PC Tail Length	3.30mm
PCB Locator	Yes
PCB Retention	Yes
PCB Thickness - Recommended	2.54mm
Pitch - Mating Interface	3.00mm
Plating min - Mating	0.381µm
Plating min - Termination	2.540µm
Polarized to Mating Part	Yes
Polarized to PCB	Yes
Shrouded	Fully
Stackable	No
Temperature Range - Operating	-40° to +105°C
Termination Interface Style	Through Hole

Solder Process Data

Max-Duration	30
Lead-Free Process Capability	SMC&WAVE
Max-Cycle	3
Max-Temp	260

Mates With / Use With

Mates with Part(s)

Description	Part Number
Micro-Fit BMI Dual Row Receptacle Housings	44133
Micro-Fit BMI Right-Angle Dual Row PCB Receptacles	44764
Micro-Fit BMI Vertical Dual Row PCB Receptacles	44769

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